

AP9469GJ-VB Datasheet N-Channel 40 V (D-S) MOSFET

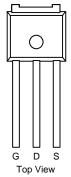
PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
40	0.0F3 at V _{GS} = 10 V	55 ^d	F9.5		
70	0.0Fl at V _{GS} = 4.5 V	I 5 ^d	1 3.3		

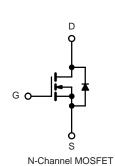
FEATURES

- · Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC









APPLICATIONS

- · Power Supply
 - Secondary Synchronous Rectification
- DC/DC Converter

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS} ± 20		v	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 25 °C	I _D	55 ^d	Α	
Continuous Diain Current (1) = 130 °C)	T _C = 70 °C	O'D	I 5 ^d		
Pulsed Drain Current		I _{DM}	165	A	
Avalanche Current		I _{AS}	H4		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	Ϊ8	mJ	
Maximum Power Discipation	T _C = 25 °C	P _D	ĺ 5.5 ^b	W	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	TD TD	2.7		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	ĺ4	°C/W
Junction-to-Case (Drain)	R _{thJC}	2.Ï	C/VV

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{DS} = 0 V, I _D = 250 μA	40			١/	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA	
		V _{DS} = 40V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
		V _{DS} = 40V , V _{GS} = 0 V, T _J = 150 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	55			Α	
Drain Source On State Resistance	Б	V _{GS} = 10 V, I _D = 22 A		0.0F3		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 20 A		0.0FI			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		1€0		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1100		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz		460			
Reverse Transfer Capacitance	C _{rss}			350			
Total Gate Charge ^c	Q_g	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 20 A		H6		nC	
Total Gate Charge				25			
Gate-Source Charge ^c	Q_{gs}	V_{DS} = 15 V, V_{GS} = 4.5 V, I_{D} = 20 A		Î			
Gate-Drain Charge ^c	Q_{gd}			Í .7			
Gate Resistance	R _g	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	16		
Rise Time ^c	t _r	V_{DD} = 15 V, R_{L} = 1.5 Ω		9	18	20	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		35	53	ns	
Fall Time ^c	t _f			9	18		
Drain-Source Body Diode Ratings ar	nd Characteris	stics T _C = 25 °C ^b					
Continuous Current	I _S				55	^	
Pulsed Current	I _{SM}				165	Α	
Forward Voltage ^a	V _{SD}	I _F = 10 A, V _{GS} = 0 V		0.75	1.5	V	
Reverse Recovery Time	t _{rr}			34	51	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 10 A, dI/dt = 100 A/μs		2	3	Α	
Reverse Recovery Charge	Q _{rr}			34	51	nC	

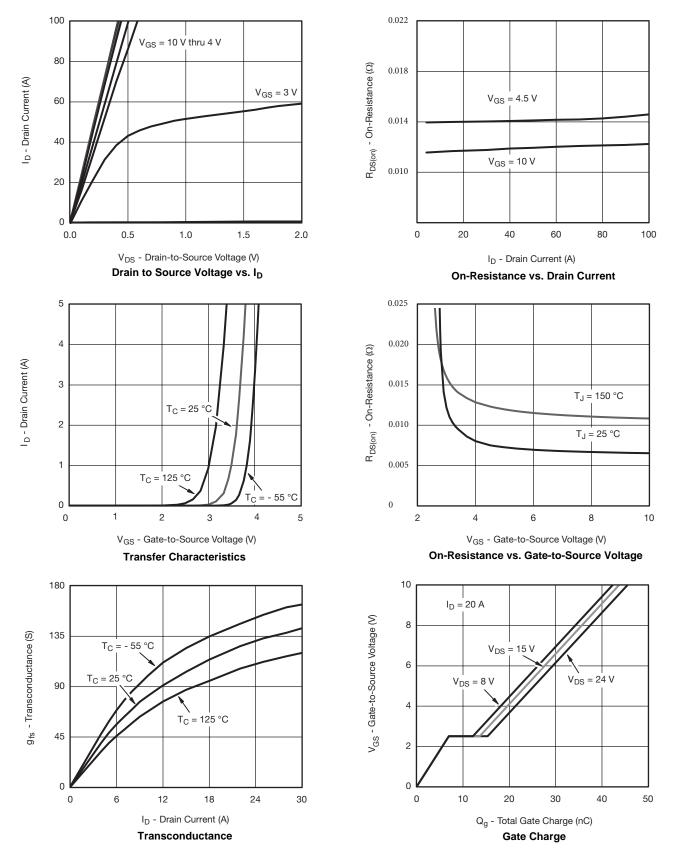
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

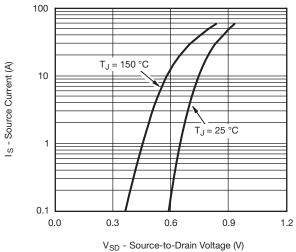


TYPICAL CHARACTERISTICS 25 C, unless otherwise noted

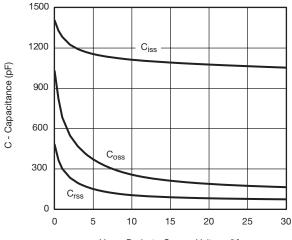




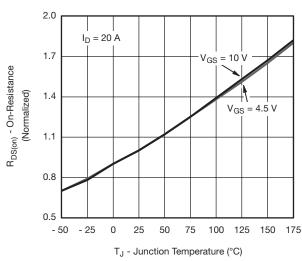
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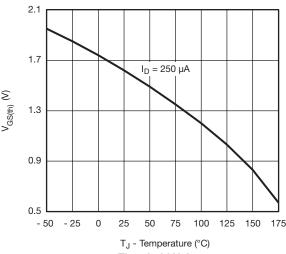
Source-Drain Diode Forward Voltage



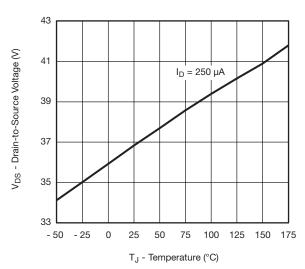
 V_{DS} - Drain-to-Source Voltage (V) $\label{eq:capacitance}$



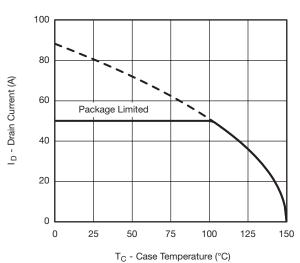
On-Resistance vs. Junction Temperature



Threshold Voltage



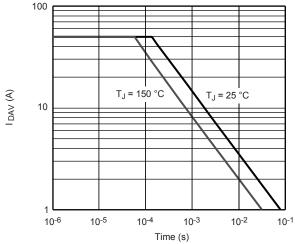
Drain Source Breakdown vs. Junction Temperature

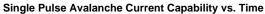


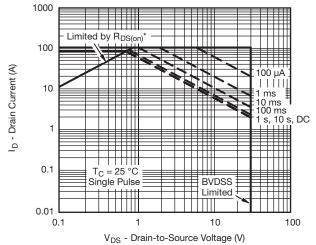
Current Derating



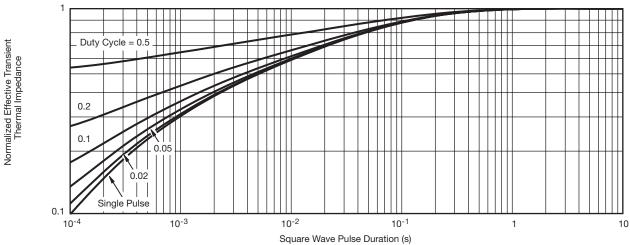
TYPICAL CHARACTERISTICS 25 C, unless otherwise noted







 * V $_{GS}$ > minimum V $_{GS}$ at which R $_{DS(on)}$ is specified **Safe Operating Area**

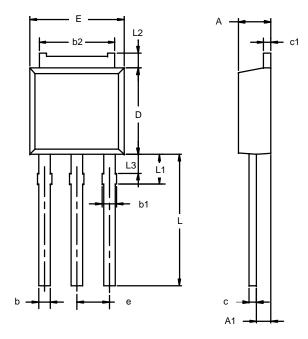


Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA

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Note: Dimension L3 is for reference only.

	MILLIMETERS		INCHES		
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A 1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
с1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28	BSC	0.090 BSC		
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	
ECN: S-0 DWG: 53	3946—Rev. E 346	E, 09-Jul-01			



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